

HiTemp ET Series Thermoelectric Cooler

Note: This product is not recommended for new designs.

This product series has been replaced with the HiTemp ETX Series. The recommended replacement is:

MFG Part Number: 387006833

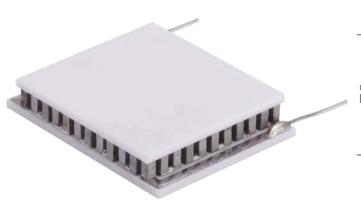
Description: OTX12-65-F2A-1312-GG-W2.25

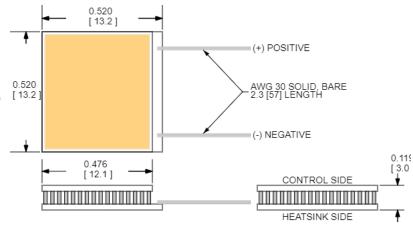
Features

- High-temperature operation
- Reliable solid-state
- No sound or vibrationEnvironmentally-friendly
- RoHS-compliant

Applications

- Peltier Cooling for Refrigerated Centrifuges
- Peltier Cooling for Machine Vision
- Thermoelectric Cooling for CMOS Sensors
- Cooling Solutions for Autonomous Systems
- Peltier Cooling for Digital
- Light Processors



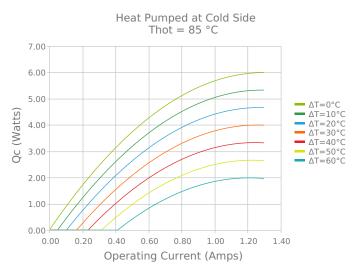


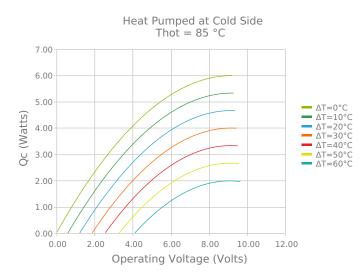
CERAMIC MATERIAL: Al₂O₃ SOLDER CONSTRUCTION: 232°C, SbSn

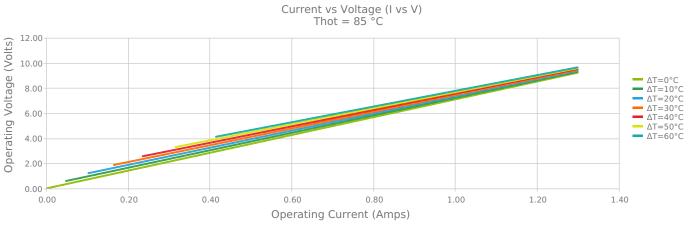
INCHES [MM]

ELECTRICAL AND THERMAL PERFORMANCE

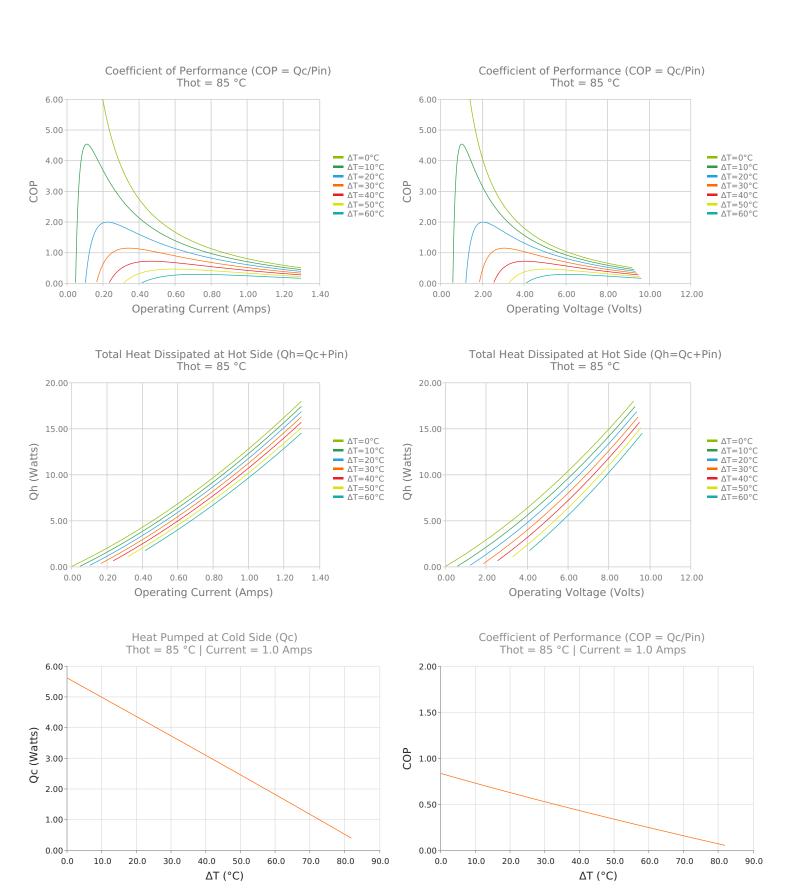
For maximum performance, be sure to orient the CONTROL side of the TEC against the application to be managed and the HEATSINK side against the heat sink or other heat rejection method. The CONTROL side is always opposite the side with lead attachments. Lead attachment is a passive heat loss and less impactful if located on the side that attaches to the heat exchanger.













SPECIFICATIONS*

Hot Side Temperature

 $Qcmax (\Delta T = 0)$

 $\Delta T max (Qc = 0)$

Imax (I @ ATmax)

Vmax (V @ Δ Tmax)

Module Resistance

Max Operating Temperature

Weight

50.0 °C	85.0 °C	110.0 °C
5.5 Watts	6.0 Watts	6.3 Watts
77.9°C	89.3°C	96.2°C
1.2 Amps	1.2 Amps	1.1 Amps
7.8 Volts	9.0 Volts	9.8 Volts
6.11 Ohms	7.09 Ohms	7.76 Ohms
150 °C		
2.0 gram(s)		

FINISHING OPTIONS

Suffix	Thickness	Flatness / Parallelism	Hot Face	Cold Face	Lead Length
GG	3.023 ±0.127 mm 0.119 ± 0.0050 in	N/A / N/A	Au Plated	Au Plated	50.8 mm 2.00 in

SEALING OPTIONS

Suffix	Sealant	Color	Temp Range	Description
None			No sealing specified	

NOTES

- 1. Max operating temperature: 150°C
- 2. Do not exceed Imax or Vmax when operating module
- 3. Reference assembly guidelines for recommended installation

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^{*} Specifications reflect thermoelectric coefficients updated March 2020